

PHOTOCOUPLER PS9117

HIGH CMR, 10 Mbps OPEN COLLECTOR OUTPUT TYPE 5-PIN SOP (SO-5) PHOTOCOUPLER -NEPOC Series-

DESCRIPTION

The PS9117 is an optically coupled high-speed, active low type isolator containing a GaAlAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

The PS9117 is designed specifically for high common mode transient immunity (CMR) and low pulse width distortion. The PS9117 is suitable for high density application.

FEATURES

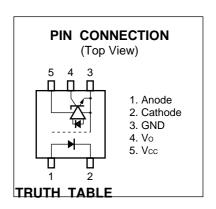
- Pulse width distortion (| tPHL tPLH | = 35 ns MAX.)
- High common mode transient immunity (CMH, CML = ± 15 kV/ μ s MIN.)
- Small package (SO-5)
- · High-speed (10 Mbps)

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- High isolation voltage (BV = 3 750 Vr.m.s.)
- · Open collector output
- Ordering number of taping product: PS9117-F3, F4: 2 500 pcs/reel
- Pb-Free product
- · Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved No. 40008902 (Option)

APPLICATIONS

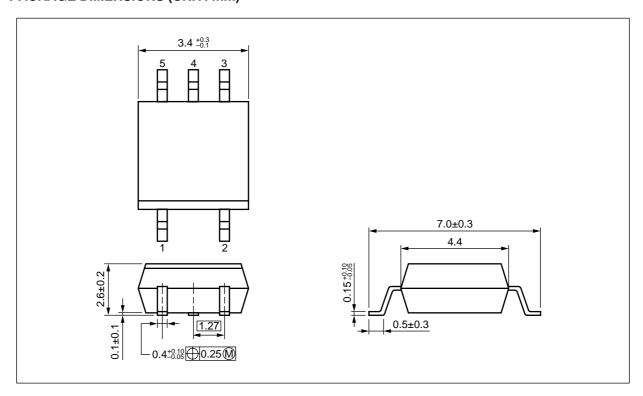
- Measurement equipment
- PDP
- FA Network



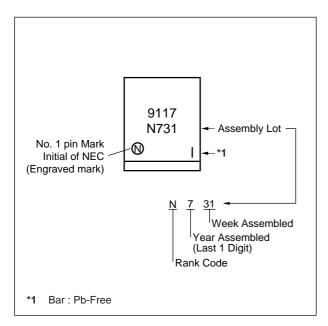
LED	Output
ON	L
OFF	Н

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<R> PACKAGE DIMENSIONS (UNIT: mm)



MARKING EXAMPLE



ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standards Approval	Application Part Number ^{*1}
PS9117	PS9117-A	Pb-Free	20 pcs (Tape 20 pcs cut)	UL approved	PS9117
PS9117-F3	PS9117-F3-A		Embossed Tape 2 500 pcs/reel		
PS9117-F4	PS9117-F4-A				
PS9117-V	PS9117-V-A		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	
PS9117-V-F3	PS9117-V-F3-A		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS9117-V-F4	PS9117-V-F4-A			Approved (Option)	

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current*1	lF	30	mA
	Reverse Voltage	VR	5	٧
Detector	Supply Voltage	Vcc	7	٧
	Output Voltage	Vo	7	٧
	Output Current	lo	25	mA
	Power Dissipation*2	Pc	40	mW
Isolation Voltage*3		BV	3 750	Vr.m.s.
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		T _{stg}	-55 to +125	°C

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^{*1} Reduced to 0.3 mA/ $^{\circ}$ C at T_A = 25 $^{\circ}$ C or more.

^{*2} Applies to output pin Vo (collector pin). Reduced to 1.5 mW/ $^{\circ}$ C at T_A = 65 $^{\circ}$ C or more.

^{*3} AC voltage for 1 minute at $T_A = 25^{\circ}C$, RH = 60% between input and output. Pins 1-2 shorted together, 3-5 shorted together.

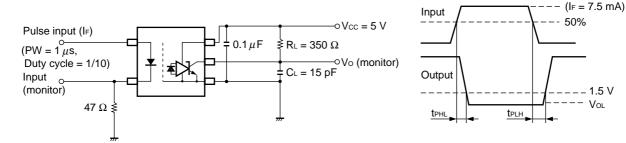
RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Low Level Input Voltage	V _{FL}	0		0.8	٧
High Level Input Current	lғн	6.3	10	12.5	mA
Supply Voltage	Vcc	4.5	5.0	5.5	٧
TTL ($R_L = 1 \text{ k}\Omega$, loads)	N			5	
Pull-up Resistor	R∟	330		4 k	Ω

ELECTRICAL CHARACTERISTICS (T_A = -40 to +85°C, unless otherwise specified)

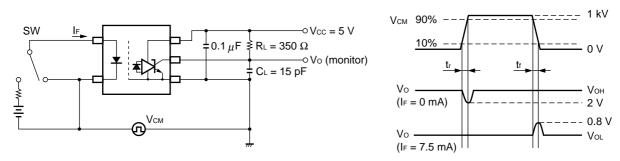
Parameter		Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA, TA = 25°C	1.4	1.65	1.8	٧
	Reverse Current	IR	Vr = 3 V, Ta = 25°C			10	μА
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz, T _A = 25°C		30		pF
Detector	High Level Output Current	Іон	Vcc = Vo = 5.5 V, V _F = 0.8 V		1	100	μА
	Low Level Output Voltage*2	Vol	Vcc = 5.5 V, I _F = 5 mA, I _{OL} = 13 mA		0.2	0.6	٧
	High Level Supply Current	Іссн	Vcc = 5.5 V, I _F = 0 mA		5	8	mA
	Low Level Supply Current	Iccl	Vcc = 5.5 V, I _F = 10 mA		9	11	
Coupled	Threshold Input Current	IFHL	$Vcc = 5 \text{ V}, Vo = 0.8 \text{ V}, RL = 350 \Omega$		2	5	
	$(H \rightarrow L)$						
	Isolation Resistance	Ri-o	V _{I-O} = 1 kV _{DC} , RH = 40 to 60%, T _A = 25°C	10 ¹¹			Ω
	Isolation Capacitance	Cı-o	V = 0 V, f = 1 MHz, T _A = 25°C		0.6		pF
	Propagation Delay Time	t PHL	T _A = 25°C		35	75	ns
	$(H \rightarrow L)^{*3}$		$V_{CC} = 5 \text{ V}, \text{ RL} = 350 \ \Omega, \text{ IF} = 7.5 \text{ mA}$			100	
	Propagation Delay Time	t PLH	T _A = 25°C		40	75	
	$(L \rightarrow H)^{*3}$		$V_{CC} = 5 \text{ V}, \text{ RL} = 350 \ \Omega, \text{ IF} = 7.5 \text{ mA}$			100	
	Rise Time	tr	$V_{CC} = 5 \text{ V}, \text{ RL} = 350 \Omega, \text{ IF} = 7.5 \text{ mA}$		20		
	Fall Time	t f			5		
	Pulse Width Distortion (PWD)*3	tphl-tplh			5	35	
	Propagation Delay Skew	t PSK				40	
	Common Mode Transient Immunity at High Level Output ^{*4}	СМн	$\label{eq:Vcc} \begin{array}{l} \mbox{Vcc} = 5 \mbox{ V, RL} = 350 \ \Omega, \mbox{ TA} = 25 \mbox{°C}, \\ \mbox{IF} = 0 \mbox{ mA, Vo} > 2 \mbox{ V, VcM} = 1 \mbox{ kV} \end{array}$	15	20		kV/μs
	Common Mode Transient Immunity at Low Level Output ^{*4}	CML	$\label{eq:VCC} \begin{aligned} &\text{Vcc} = 5 \text{ V, RL} = 350 \ \Omega, \text{Ta} = 25^{\circ}\text{C}, \\ &\text{If} = 7.5 \text{ mA, Vo} < 0.8 \text{ V, Vcm} = 1 \text{ kV} \end{aligned}$	15	20		kV/μs

- *1 Typical values at T_A = 25°C
- *2 Because Vol of 2 V or more may be output when LED current input and when output supply of Vcc = 2.6 V or less, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device.
- *3 Test circuit for propagation delay time



Remark C_L includes probe and stray wiring capacitance.

*4 Test circuit for common mode transient immunity

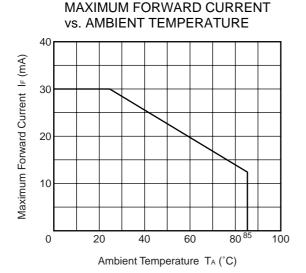


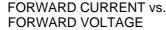
Remark CL includes probe and stray wiring capacitance.

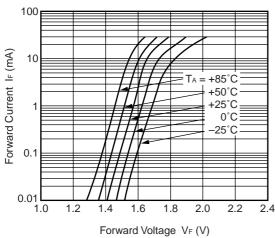
USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1 μ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.

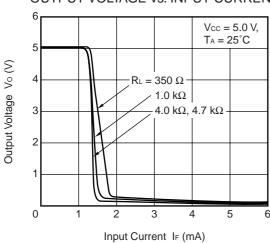
TYPICAL CHARACTERISTICS (Ta = 25°C, unless otherwise specified)



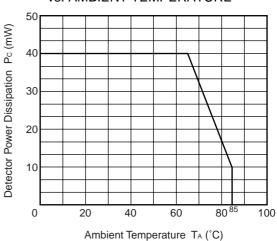




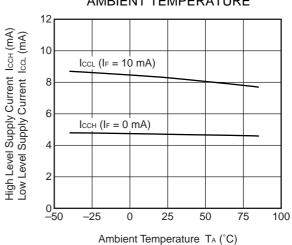
OUTPUT VOLTAGE vs. INPUT CURRENT



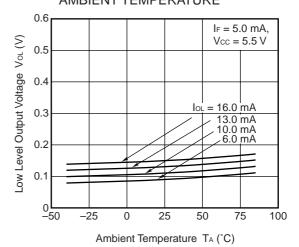
DETECTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



SUPPLY CURRENT vs.
AMBIENT TEMPERATURE

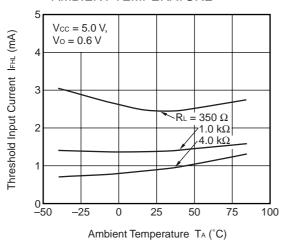


LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE

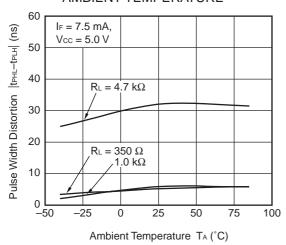


Remark The graphs indicate nominal characteristics.

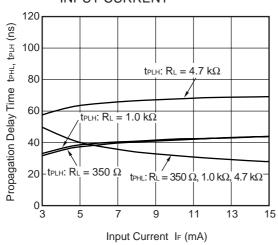
THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE



PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE

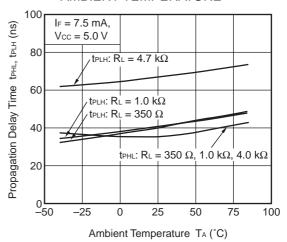


PROPAGATION DELAY TIME vs. INPUT CURRENT

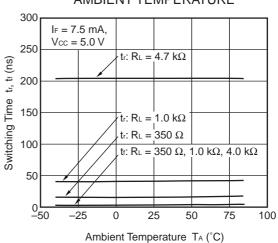


Remark The graphs indicate nominal characteristics.

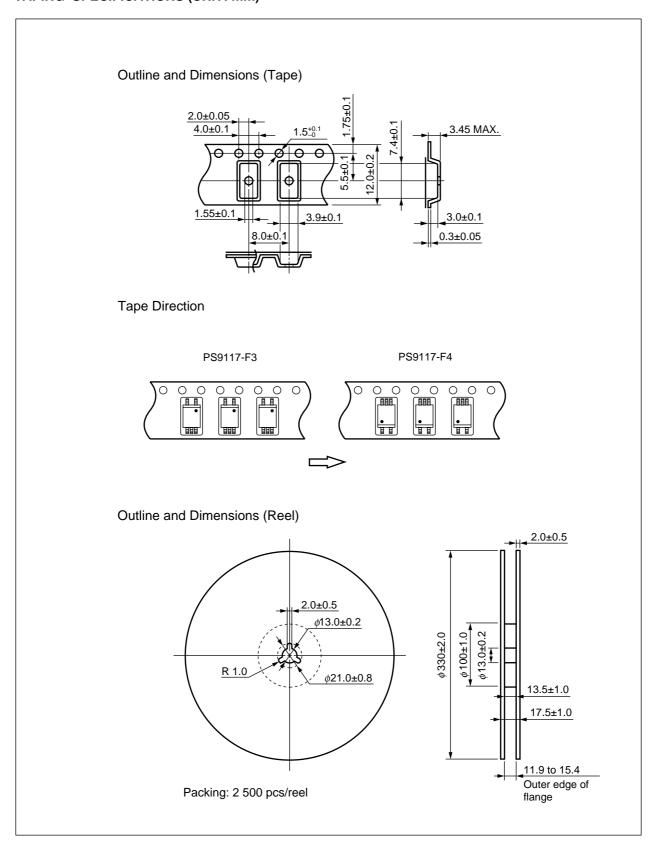
PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE



SWITCHING TIME vs. AMBIENT TEMPERATURE



TAPING SPECIFICATIONS (UNIT: mm)



NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

Peak reflow temperature
 260°C or below (package surface temperature)

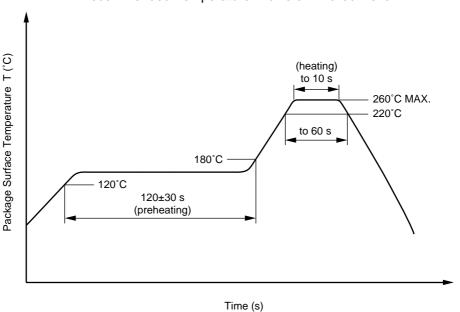
Time of peak reflow temperature
 Time of temperature higher than 220°C
 60 seconds or less

Time to preheat temperature from 120 to 180°C 120±30 s
 Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120°C or below (package surface temperature)

• Number of times One (Allowed to be dipped in solder including plastic mold portion.)

Flux
 Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak Temperature (lead part temperature) 350°C or below
 Time (each pins) 3 seconds or less

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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M8E 02.11-1

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
 - 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.



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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

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